

## KLT-B6MF-IMX214 V1.0

### 13MP Sony IMX214 MIPI Interface M12 Fixed Focus Camera Module



Front View



Back View

#### Specifications

Camera Module No.	<b>KLT-B6MF-IMX214 V1.0</b>
Resolution	13MP
Image Sensor	IMX214
Sensor Type	1/3.06"
Pixel Size	1.12 um x 1.12 um
EFL	2.27 mm
F.NO	2.40
Pixel	4224 x 3136
View Angle	152.0°(DFOV) 122.0°(HFOV) 93.0°(VFOV)
Lens Dimensions	13.00 x 13.00 x 22.82 mm
Module Size	60.00 x 22.00 mm
Module Type	Fixed Focus
Interface	MIPI
Auto Focus VCM Driver IC	None
Lens Model	KLT-LENS-YM6081
Lens Type	650nm IR Cut
Operating Temperature	-20°C to +70°C
Mating Connector	DF30FC-30DS-0.4V



## KLT-B6MF-IMX214 V1.0

### 13MP Sony IMX214 MIPI Interface M12 Fixed Focus Camera Module



Top View



Side View

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Bottom View

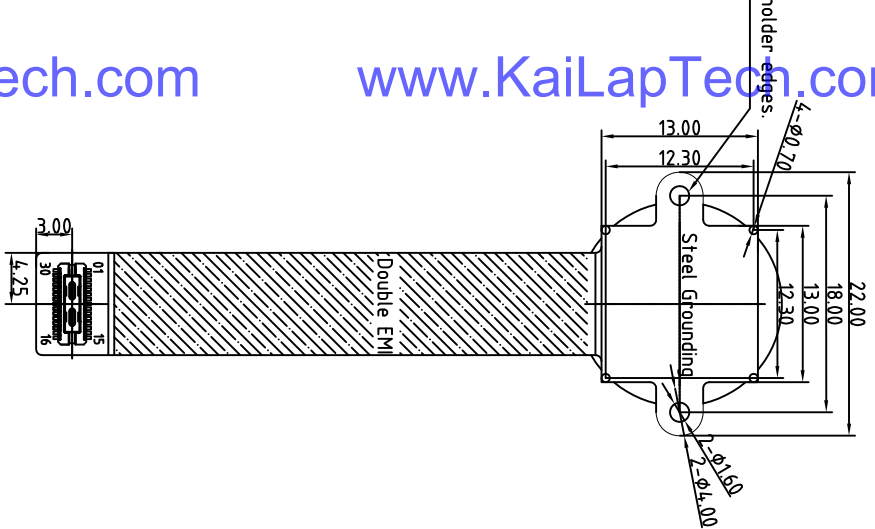
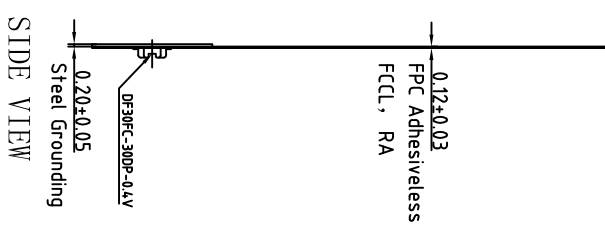
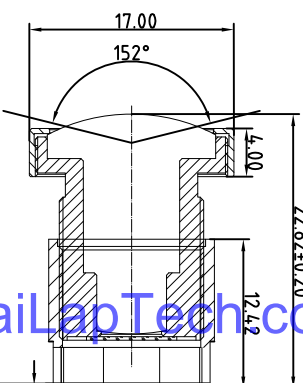
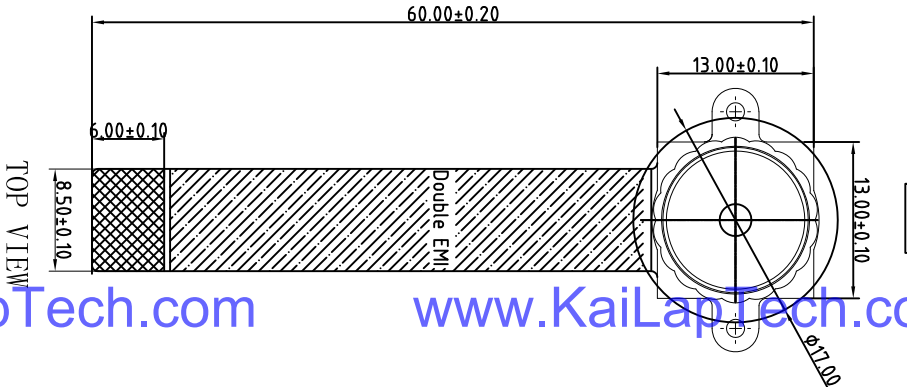


Mating Connector

# ROHS

## PIN SIGNAL

1	NC
2	NC
3	DVDD1.2V
4	DOVDD1.8V
5	NC
6	AGND
7	AVDD2.8V
8	DGND
9	SDA
10	SCL
11	RST
12	PWDN
13	GND
14	MCCLK
15	GND
16	MDP3
17	MDN3
18	GND
19	MDP2
20	MDN2
21	GND
22	MDP1
23	MDN1
24	GND
25	MCP
26	MCN
27	GND
28	MDP0
29	MDN0
30	GND



NOTE: BOTTOM VIEW  
1. The device slave address: 0x20(w); 0x21(r)

### Parameters:

### 1、Sensor specification:

Image Sensor: IMX214  
Pixel: 1.12umx1.12um  
Lens Type: 1/3.06  
Important Voltage Description: DVDD1.2V (external power supply);

### 2、Lens specification:

FOV: 152°(D), 122°(H), 93°(V)  
F/NO: 2.4  
TV distortion: < -15%  
Focal length: 2.27mm  
Composition: 6G+IR FILTER  
IR Cut Coating: 650nm±10nm@50%

## Kai Lap Technologies Group Ltd

Designed By	Kevin	Model Name:	KLT-B6MF-IMX214 V1.0	
Checked By	Aouly Yan	Projection Type:	Third Angle	Unit: mm
		Scale:	1:1	Material: -----
		Sheet:	1 of 1	Version: 1/0

Version	Mark	Information	Date
V1.0	PD	First Version	2018-03-31



Lens Model: KLT-LENS-YM6081

No.	ITEM	SPECIFICATION
1	孔径 (EFL)	2.25mm
2	光学后焦 (BFL)	3.94mm (IR0.21mm)
3	机械后焦 (MFL)	4.37mm (IR0.21mm)
4	光学总长 (TTL)	2.20mm (IR0.21mm)
5	光瞳 (FNo)	2.8
6	最大像面/机械像面 (C-obj)	6.54IR
7	光学材料 (Structure)	M12xP0.5
8	光学涂层 (Special Transmitt)	Trans=99.9%
9	光轴歪扭率 (Special Transmitt)	IMX214
Sensor		
视场角 (FOV)		Vertical 89.1° Horizontal 130.0° Diagonal 149.4° (y=2.857)
11	光学公差 (Optical Dimension)	-64.3%
12	制程公差 (Process)	65.3%
13	主光线角度 (CRA)	29.7°
14	R FILTER SPEC (Built-in Other's raw area)	Tavg=89% @ 420-660nm Tavg=50% @ 570-1100nm T<5% @ 700-1000nm T<5% @ 1060nm

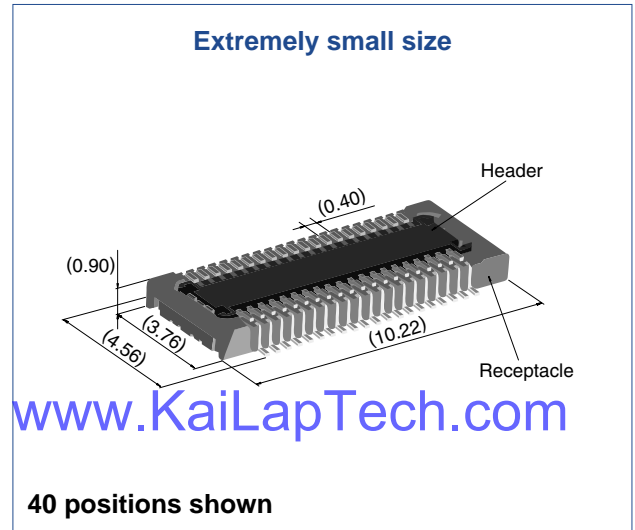
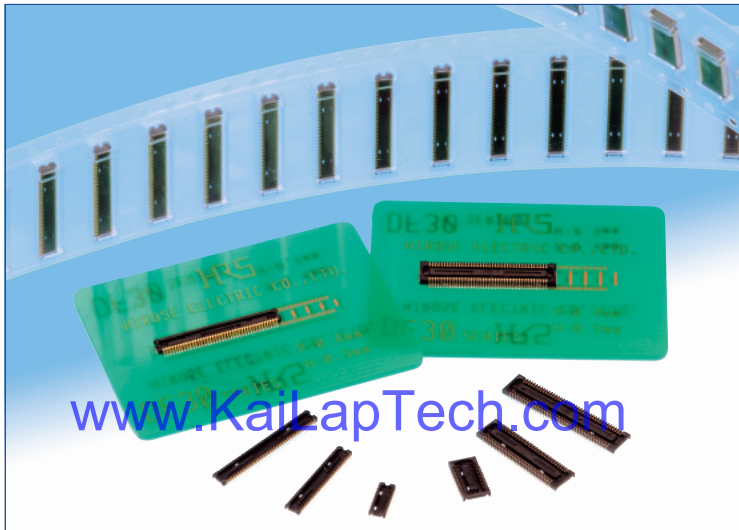
设计	处数	分区	更改文件号	签名	年、月、日
审核		20210427	标准化		
工艺			批准		

阶段标记	重量比例
	1:1
共	张
第	张

# 0.4 mm Pitch, 0.9 mm Height, Board-to-Board / Board-to-FPC Connectors

## DF30 Series



### Overview

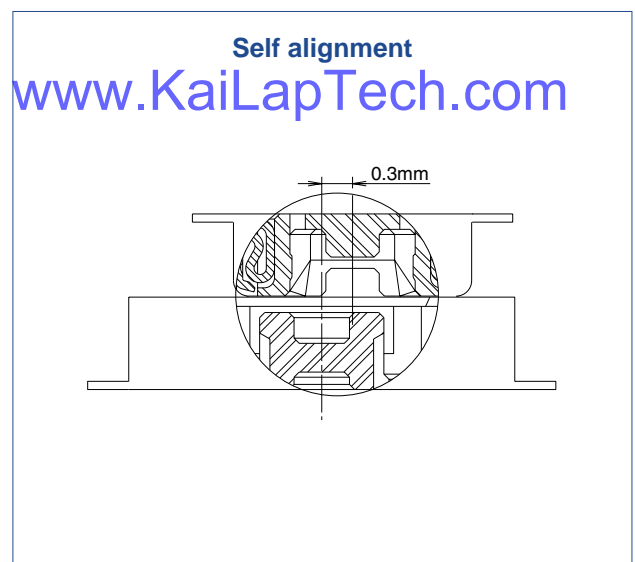
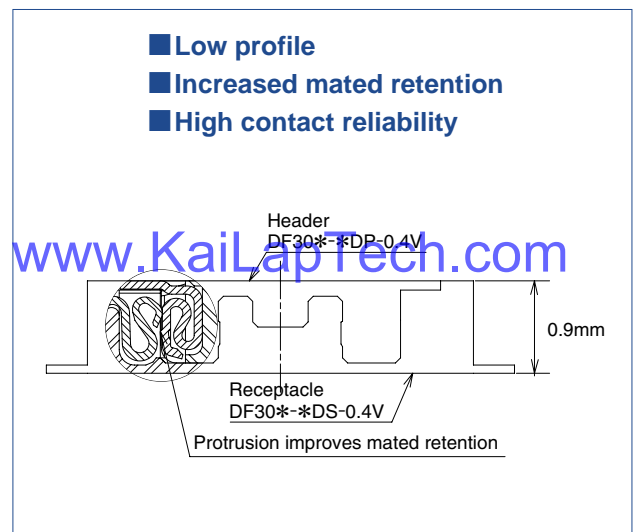
Continuous miniaturization and increased component density on PCB created demand for extremely low profile connectors. This series is addition of a new extremely low profile connectors to Hirose's wide range of high reliability board-to-board/board-to-FPC connection solutions.

### Features

- 1. Contact reliability**  
Concentration of the contact's normal forces at the single point assures good contact wipe and electrical reliability, while confirming the fully mated condition with a definite tactile click.
- 2. Self alignment**  
Recognizing the difficulties of mating extremely small connectors in limited spaces the connectors will self align in horizontal axis within 0.3 mm.
- 3. Automatic board placement**  
Packaged on tape-and-reel the plug and headers have sufficiently large flat areas to allow pick-up with vacuum nozzles of automatic placement equipment.
- 4. Variety of contact positions and styles**  
Available in standard contact positions of: 20, 22, 24, 30, 34, 40, 50, 60, 70 and 80 with and without metal fittings. Addition of metal fittings does not affect external dimensions of the connectors. Smaller contact positions are also available.
- 5. Support for continuity test connector**  
Connectors which have increased insertion and removal durability are available for continuity tests. Contact your Hirose sales representative for details.

### Applications

Cellular phones, PDA's, mobile computers, digital cameras, digital video cameras, and other devices demanding high reliability connections in extremely limited spaces.



## Product Specifications

Rating	Rated current 0.3A Rated voltage 30V AC	Operating temperature range : -35°C to 85°C (Note 1) Operating humidity range : Relative humidity 20% to 80%	Storage temperature range -10°C to 60°C (Note 2) Storage humidity range Relative humidity 40% to 70% (Note 2)
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Item	Specification	Conditions
1. Insulation resistance	50 MΩ min.	100V DC
2. Withstanding voltage	No flashover or insulation breakdown.	100V AC / one minute
3. Contact resistance	100 mΩ max.	100 mA
4. Vibration	No electrical discontinuity of 1 μs or more	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours, 3 axis
5. Humidity	Contact resistance: 100 mΩ max. Insulation resistance: 25 MΩ min.	96 hours at temperature of 40°C±2°C and RH of 90% to 95%
6. Temperature cycle	Contact resistance: 100 mΩ max. Insulation resistance: 50 MΩ min.	Temperature: -55°C→+5°C to +35°C→+85°C→+5°C to +35°C Duration: 30→10→30→10(Minutes) 5 cycles
7. Durability (insertions/withdrawals)	Contact resistance: 100 mΩ max.	50 cycles (Connector for conductivity tests: 500 cycles)
8. Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 300°C for 3 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

## Materials and Finishes

Connectors	Component	Material	Finish	Remarks
Receptacles and Headers	Insulator	LCP	Color : Black	UL94V-0
	Contacts	Phosphor bronze	Gold plated	
	Metal fittings	Phosphor bronze	Tin-copper plated	

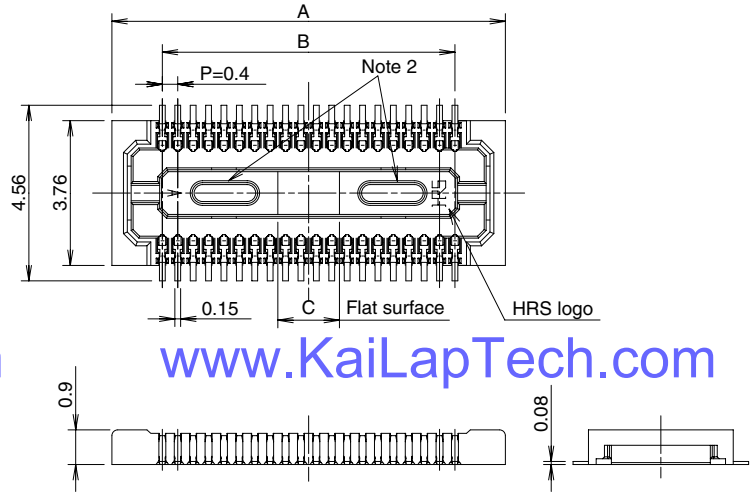
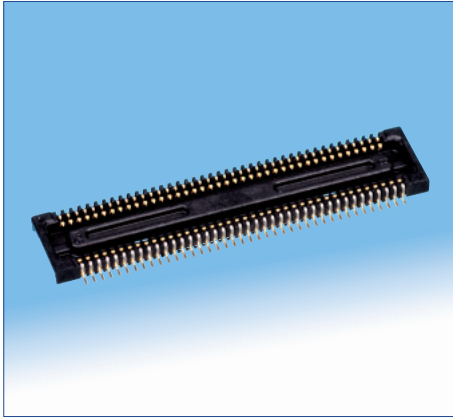
## Ordering information

### ● Receptacles and Headers

**DF30 FC - \* DS - 0.4 V (\*\*)**  
1 2 3 4 5 6 7

① Series name: DF30	⑤ Contact pitch: 0.4 mm
② Configuration FB: With metal fittings, without bosses FC: Without metal fittings, without bosses CJ: Connector for conductivity tests	⑥ Termination section V: Straight SMT
③ Number of positions: 20, 22, 24, 30, 34, 40, 50, 60, 70, 80	⑦ Packaging (81): Embossed tape packaging (5,000 pieces per reel) (82): Embossed tape packaging (1,000 pieces per reel)
④ Connector type DS: Double row receptacle DP: Double row header	

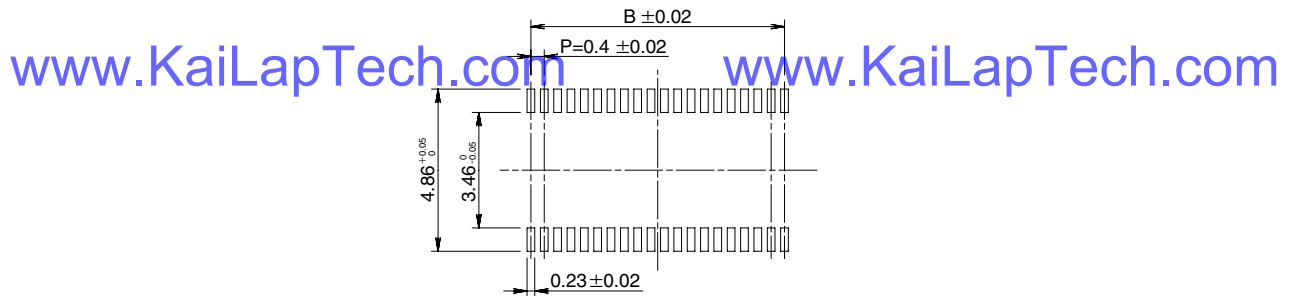
## ■ Receptacles (without metal fittings)



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## ◆ Recommended PCB mounting pattern



Recommended solder paste thickness: 120 μm

[www.KaiLapTech.com](http://www.KaiLapTech.com) [Specification number] -\*\*, (\*\*)  
(81): Embossed tape packaging (5 000 pieces per reel) [www.KaiLapTech.com](http://www.KaiLapTech.com)

\* Tolerances non- accumulative.

Unit: mm

Part Number	CL No.	Number of contacts	A	B	C
DF30FC-20DS-0.4V(**)	CL684-1109-8-**	20	6.22	3.6	1.2
DF30FC-22DS-0.4V(**)	CL684-1110-7-**	22	6.62	4.0	1.2
DF30FC-24DS-0.4V(**)	CL684-1111-0-**	24	7.02	4.4	1.2
DF30FC-30DS-0.4V(**)	CL684-1112-2-**	30	8.22	5.6	1.2
DF30FC-34DS-0.4V(**)	CL684-1113-5-**	34	9.02	6.4	1.36
DF30FC-40DS-0.4V(**)	CL684-1078-6-**	40	10.22	7.6	1.6
DF30FC-50DS-0.4V(**)	CL684-1114-8-**	50	12.22	9.6	2.0
DF30FC-60DS-0.4V(**)	CL684-1082-3-**	60	14.22	11.6	2.4
DF30FC-70DS-0.4V(**)	CL684-1115-0-**	70	16.22	13.6	2.8
DF30FC-80DS-0.4V(**)	CL684-1116-3-**	80	18.22	15.6	3.2

Note 1: Order by number of reels.

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

## [Product Brief]

Ver.1.0

# IMX214

Diagonal 5.867mm (Type 1/3.06) 13M Pixel CMOS Image Sensor with Square Pixel for Color Cameras

### Description

IMX214 is a diagonal 5.867mm (Type 1/3.06) 13M pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor RS™ technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. By introducing specially varying exposure technology, high dynamic range still pictures and movies are achievable. It equips an electronic shutter with variable integration time. It operates with three power supply voltages: analog 2.7 V, digital 1.0V and 1.8 V for input/output interface and achieves low power consumption. IMX214 is designed for use in cellular phones or tablet devices\*.

### Functions and Features

- ◆ Back illuminated and stacked CMOS image sensor Exmor RS
- ◆ Single Frame High Dynamic Range (HDR) with equivalent full pixels.
- ◆ High signal to noise ratio (SNR).
- ◆ Full resolution @30fps (Normal / HDR) 4K2K @30fps (Normal / HDR) 1080p @60fps (Normal / HDR)
- ◆ Output video format of RAW10/8, COMP8/6
- ◆ Pixel binning readout and H/V sub sampling function
- ◆ Advanced Noise Reduction (Chroma noise reduction and luminance noise reduction)
- ◆ Independent flipping and mirroring.
- ◆ CSI 2 serial data output (MIPI 2lane/4lane, Max. 1.2Gbps/lane, DPHY spec. ver. 1.1 compliant)
- ◆ 2wire serial communication
- ◆ Two PLLs for independent clock generation for pixel control and data output interface.
- ◆ Advanced Noise Reduction.
- ◆ Dynamic Defect Pixel Correction.
- ◆ Zero shutter lag.
- ◆ Power on reset function
- ◆ Dual sensor synchronization operation.
- ◆ 8K bit of OTP ROM for users.
- ◆ Built in temperature sensor

#### NOTE)

1. When using this product for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and Tablet PCs. Consult your Sony sales representative if you have any questions.



**Device Structure**

- ◆ CMOS image sensor
- ◆ Image size : Diagonal 5.867mm (Type 1/3.06)
- ◆ Total number of pixels : 4224 (H) × 3200(V) approx. 13.51M pixels
- ◆ Number of effective pixels : 4224 (H) × 3136 (V) approx. 13.25 M pixels
- ◆ Number of active pixels : 4208 (H) × 3120 (V) approx. 13.13 M pixels
- ◆ Chip size : 6.100mm (H) × 4.524mm (V)
- ◆ Unit cell size : 1.12 μm (H) × 1.12 μm (V)
- ◆ Substrate material : Silicon

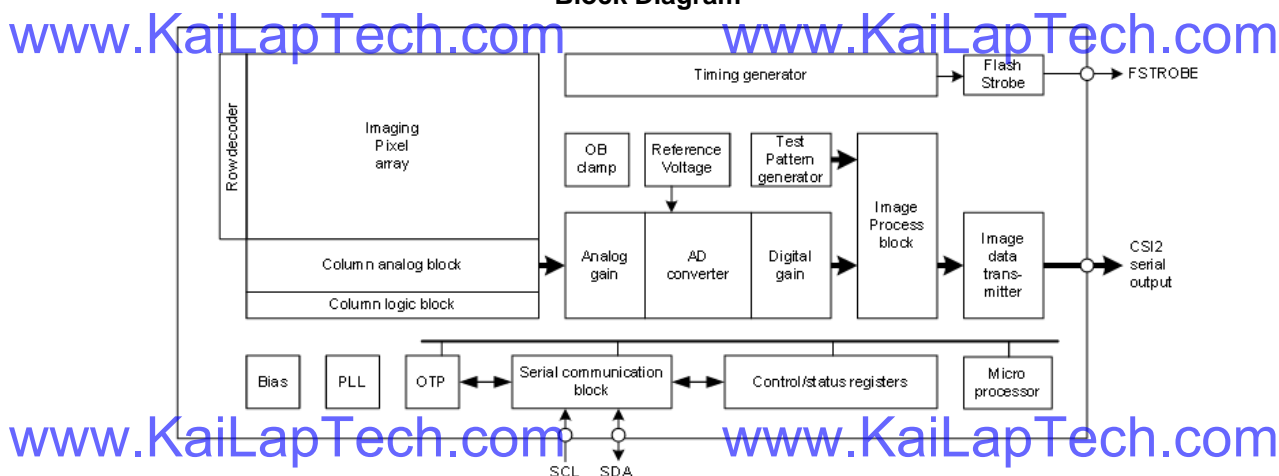
**Functional Description**

**System Outline**

IMX214 is a CMOS active pixel type image sensor which adopts the Exmor RS™ technology to achieve high sensitivity, low noise and high speed image capturing. It is embedded with backside illuminated imaging pixel, low noise analog amplifier, column parallel A/D converters which enables high speed capturing, digital amplifier, image binning circuit, timing control circuit for imaging size and frame rate, CSI2 image data high speed serial interface, PLL oscillator, and serial communication interface to control these functions.

Several additional image processing functions and peripheral circuits are also included for easy system optimization by the users. A one time programmable memory is embedded in the chip for storing the user data. It has 8 K-bit for users, 10 K-bit as a whole.

**Block Diagram**



**Exmor RS**

\* Exmor RS is a trademark of Sony Corporation. The Exmor RS is a Sony's CMOS image sensor with high-resolution, high-performance and compact size by replacing a supporting substrate in Exmor R™ which changed fundamental structure of Exmor™ pixel adopted column parallel A/D converter to back-illuminated type, with layered chips formed signal processing circuits.

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Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.



## Camera Module Pinout Definition Reference Chart

OmniVision	Sony	Samsung	On-Semi	Aptina	Himax	GalaxyCore	PixArt	SmartSens	Sensors	
Pin Signal										
Description										
DGND GND										ground for digital circuit
AGND										ground for analog circuit
PCLK DCK										DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY										power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK										system input clock
RESET RST										reset active low with internal pull-up resistor
NC NULL										no connect
SDA SIO_D SIOD										SCCB data
SCL SIO_C SIOC										SCCB input clock
VSYNC XVS FSYNC										DVP VSYNC output
HREF XHS										DVP HREF output
DOVDD										power for I/O circuit
AFVDD										power for VCM circuit
AVDD										power for analog circuit
DVDD										power for digital circuit
STROBE FSTROBE										strobe output
FSIN										synchronize the VSYNC signal from the other sensor
SID										SCCB last bit ID input
ILPWM										mechanical shutter output indicator
FREQ										frame exposure / mechanical shutter
GPIO										general purpose inputs
SLASEL										I2C slave address select
AFEN										CEN chip enable active high on VCM driver IC
<b>MIPI Interface</b>										
MDN0 DN0 MD0N DATA_N DMO1N										MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P										MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N										MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P										MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N										MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P										MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N										MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P										MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN										MIPI clock negative output
MCP CLKP MCP CLK_P DCKN										MIPI clock positive output
<b>DVP Parallel Interface</b>										
D0 DO0 Y0										DVP data output port 0
D1 DO1 Y1										DVP data output port 1
D2 DO2 Y2										DVP data output port 2
D3 DO3 Y3										DVP data output port 3
D4 DO4 Y4										DVP data output port 4
D5 DO5 Y5										DVP data output port 5
D6 DO6 Y6										DVP data output port 6
D7 DO7 Y7										DVP data output port 7
D8 DO8 Y8										DVP data output port 8
D9 DO9 Y9										DVP data output port 9
D10 DO10 Y10										DVP data output port 10
D11 DO11 Y11										DVP data output port 11



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## Cameras Applications



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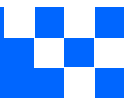


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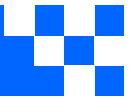




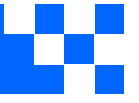
## Camera Reliability Test

Reliability Inspection Item		Testing Method	Acceptance Criteria	
Category	Item			
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional	
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional





Inspection Item		Inspection Method	Standard of Inspection	
Category	Item			
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed
		Gap	The Naked Eye	Meet the Height Standard
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard
		Contamination	The Naked Eye	No Effect On Resolution Standard
		Oil Film	The Naked Eye	No Effect On Resolution Standard
		Cover Tape	The Naked Eye	No Issue On Appearance.
	Function	Image	No Communication	Test Board
Bright Pixel			Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center
Blurry			The Naked Eye	Not Allowed
No Image			The Naked Eye	Not Allowed
Vertical Line			The Naked Eye	Not Allowed
Horizontal Line			The Naked Eye	Not Allowed
Light Leakage			The Naked Eye	Not Allowed
Blinking Image			The Naked Eye	Not Allowed
Bruise			Inspection Jig	Not Allowed
Resolution			Chart	Follows Outgoing Inspection Chart Standard
Color			The Naked Eye	No Issue
Noise			The Naked Eye	Not Allowed
Corner Dark			The Naked Eye	Less Than 100px By 100px
Color Resolution			The Naked Eye	No Issue
Dimension	Height	The Naked Eye	Follows Approval Data Sheet	
	Width	The Naked Eye	Follows Approval Data Sheet	
	Length	The Naked Eye	Follows Approval Data Sheet	
	Overall	The Naked Eye	Follows Approval Data Sheet	



## KLT Package Solutions

KLT Camera Module



Complete with Lens Protection Film

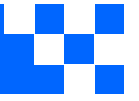


Tray with Grid and Space



Place Cameras on the Tray





## Camera Modules Package Solution

Full Tray of Cameras



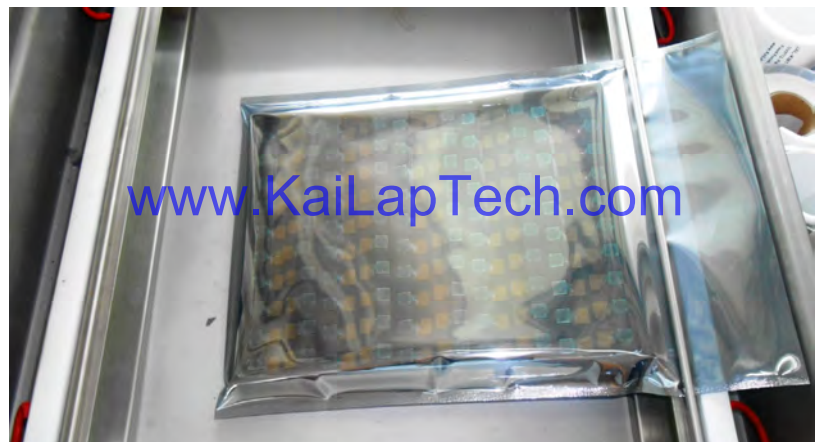
Cover Tray with Lid



Put Tray into Anti-Static Bag



Vacuum the Anti-Static Bag





## Camera Modules Package Solution

**Sealed Vacuum Bag with Labels**

- 1. Model and Description 2. Quantity 3. Shipping Date 4. Caution**







# CMOS CAMERA MODULES



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## Large Order Package Solution

Place Foam Sheets Between Trays

Foam Sheets are Slightly Larger than Trays



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Place Foam Sheets and Trays into Box

Foam Sheets are Tightly Fitting Box



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## Small Order Package Solution

Place Foam Sheets and Trays into Small Box



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Package in Small Box for Shipment

Foam Sheets are Nicely Fitting the Small Box



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Place Small Boxes into Larger Box



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## Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



### Carbon Box Ready for Shipment

1. Delivery Address and Phone No.
2. Box No. and Ship Date
3. Fragile Caution





## Sample Order Package Solution

Place Sample into Small Anti-Static Bag



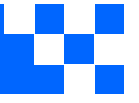
Place Connectors into Small Ant-Static Bag



### Sample Labels on the Small Bag

1. Camera Module or Connector Model
2. Shipping Date and Quantity
3. Caution





## Connectors Large Order Package Solution

Connectors in a Wheel



Label Connectors in the Wheel



The Wheel is Perfectly Fitting the Box



Connectors Box Ready for Shipment



## Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.

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## Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, [www.KaiLapTech.com](http://www.KaiLapTech.com). Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequent events.





# CMOS CAMERA MODULES



*your BEST camera module partner*

## KLT Strength

### Powerful Factory



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